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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	-
Core Size	8-Bit
Speed	12MHz
Connectivity	SIO, UART/USART
Peripherals	PWM, WDT
Number of I/O	88
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 15x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-PQFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/onsemi/lc87f5lp6auej-3e

■UART: 2 channels

- 1) Full duplex
- 2) 7/8/9 bit data bits selectable
- 3) 1 stop bit (2 bits in continuous transmission mode)
- 4) Built-in baudrate generator (with baudrates of 16/3 to 8192/3 tCYC)

■AD Converter

- 8 bits × 15 channels

■PWM

- Multifrequency 12-bit PWM × 4 channels

■Remote Control Receiver Circuit (sharing pins with P73, INT3, and T0IN)

- 1) Noise filtering function (noise filter time constant selectable from 1 tCYC, 32 tCYC, and 128 tCYC)
- 2) The noise filtering function is available for the INT3, T0IN, or T0HCP signal at P73. When P73 is read with an instruction, the signal level at that pin is read regardless of the availability of the noise filtering function.

■Watchdog Timer

- 1) External RC watchdog timer
- 2) Interrupt and reset signals selectable

■Interrupts

- 29 sources, 10 vector addresses
 - 1) Provides three levels (low (L), high (H), and highest (X)) of multiplex interrupt control. Any interrupt requests of the level equal to or lower than the current interrupt are not accepted.
 - 2) When interrupt requests to two or more vector addresses occur at the same time, the interrupt of the highest level takes precedence over the other interrupts. For interrupts of the same level, the interrupt into the smallest vector address takes precedence.

No.	Vector Address	Level	Interrupt Source
1	00003H	X or L	INT0
2	0000BH	X or L	INT1
3	00013H	H or L	INT2/T0L/INT4
4	0001BH	H or L	INT3/INT5/base timer
5	00023H	H or L	T0H/INT6
6	0002BH	H or L	T1L/T1H/INT7
7	00033H	H or L	SIO0/UART1 receive/ UART2 receive
8	0003BH	H or L	SIO1/SIO2/UART1 transmit/UART2 transmit
9	00043H	H or L	ADC/T6/T7/PWM4, PWM5
10	0004BH	H or L	Port 0/T4/T5/PWM0, PWM1

- Priority levels X > H > L
- Of interrupts of the same level, the one with the smallest vector address takes precedence.

■Subroutine Stack Levels

- 4096 levels maximum (the stack is allocated in RAM)

■High-speed Multiplication/Division Instructions

- 16-bits × 8-bits (5 tCYC execution time)
- 24-bits × 16-bits (12 tCYC execution time)
- 16-bits ÷ 8-bits (8 tCYC execution time)
- 24-bits ÷ 16-bits (12 tCYC execution time)

■Oscillation Circuits

- RC oscillation circuit (internal) : For system clock
- CF oscillation circuit : For system clock, with internal Rf
- Crystal oscillation circuit : For low-speed system clock
- Multifrequency RC oscillation circuit (internal) : For system clock

■System Clock Divider Function

- Can run on low current.
- The minimum instruction cycle selectable from 300ns, 600ns, 1.2μs, 2.4μs, 4.8μs, 9.6μs, 19.2μs, 38.4μs, and 76.8μs (at a main clock rate of 10MHz).
- The minimum instruction cycle selectable from 250ns, 500ns, 1.0μs, 2.0μs, 4.0μs, 8.0μs, 16.0μs, 32.0μs, and 64.0μs (at a main clock rate of 12MHz).

■Standby Function

- HALT mode: Halts instruction execution while allowing the peripheral circuits to continue operation.
 - 1) Oscillation is not halted automatically.
 - 2) Canceled by a system reset or occurrence of interrupt.
- HOLD mode: Suspends instruction execution and the operation of the peripheral circuits.
 - 1) The CF, RC, and crystal oscillators automatically stop operation.
 - 2) There are three ways of resetting the HOLD mode.
 - (1) Setting the reset pin to the lower level.
 - (2) Setting at least one of the INT0, INT1, INT2, INT4, and INT5 pins to the specified level
 - (3) Having an interrupt source established at port 0
- X'tal HOLD mode: Suspends instruction execution and the operation of the peripheral circuits except the base timer.
 - 1) The CF and RC oscillators automatically stop operation.
 - 2) The state of crystal oscillation established when the HOLD mode is entered is retained.
 - 3) There are four ways of resetting the X'tal HOLD mode.
 - (1) Setting the reset pin to the low level
 - (2) Setting at least one of the INT0, INT1, INT2, INT4, and INT5 pins to the specified level
 - (3) Having an interrupt source established at port 0
 - (4) Having an interrupt source established in the base timer circuit

■On-chip Debugger Function

- Permits software debugging with the test device installed on the target board.

■Package Form

- QIP100E (14 × 20) : “Lead-free type”
- TQFP100 (14 × 14) : “Lead-free type”

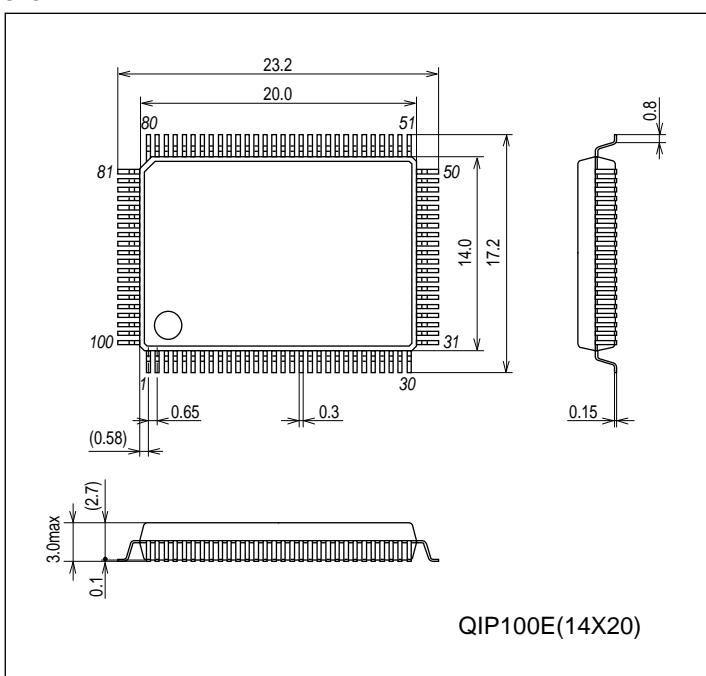
■Development Tools

- Evaluation (EVA) chip : LC87EV690
- Emulator : EVA62S + ECB876600D + SUB875C00 + POD100QFP or POD100SQFP Type B
ICE-B877300 + SUB875C00 + POD100QFP or POD100SQFP Type B
- Flash ROM writer adapter : W87F52256Q(QIP100E), W87F52256SQ(TQFP100)

Package Dimensions

unit : mm (typ)

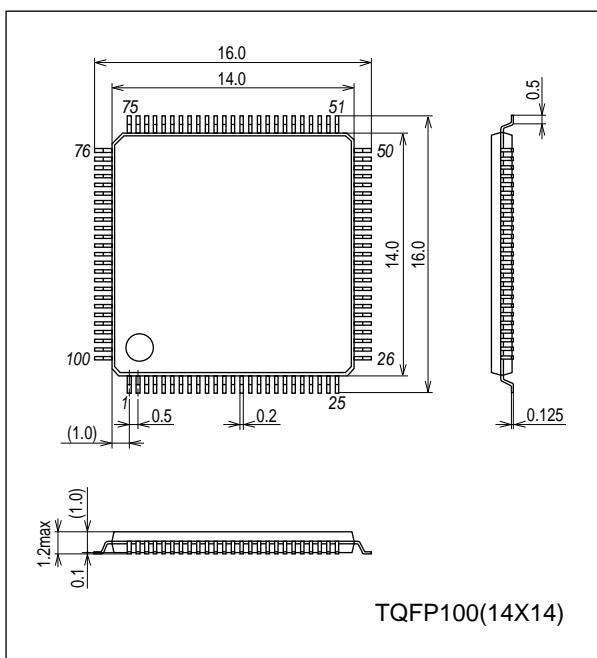
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Package Dimensions

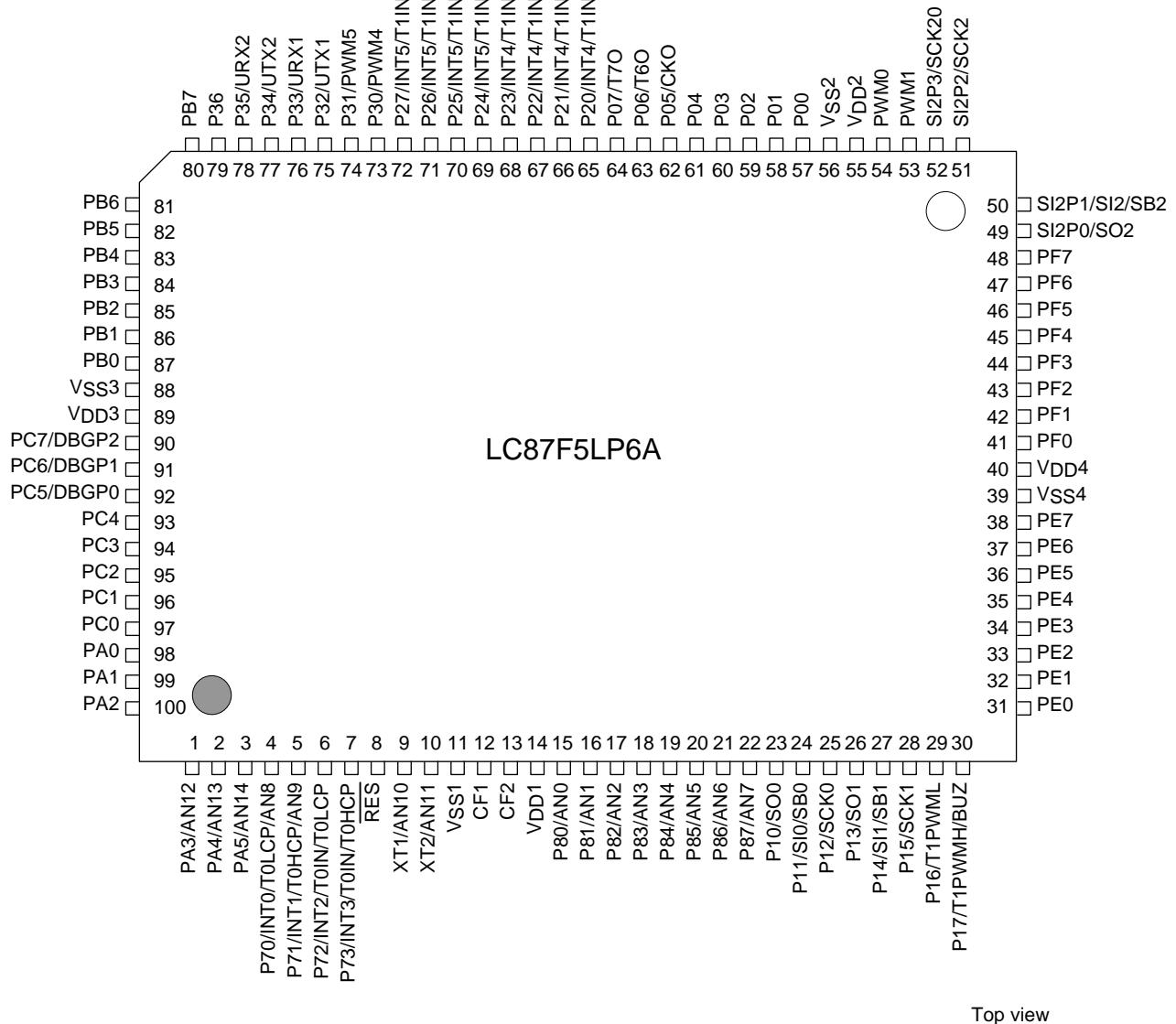
unit : mm (typ)

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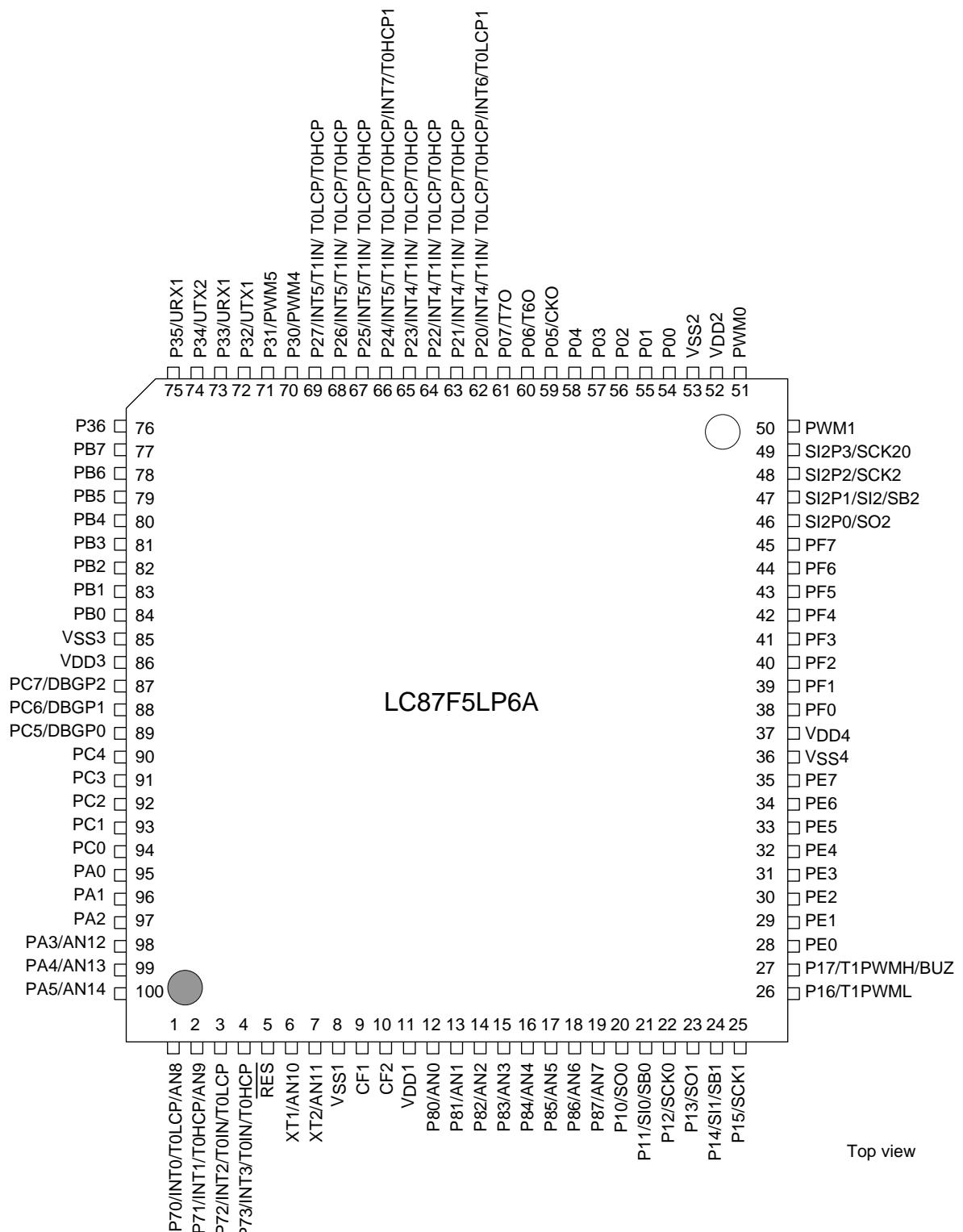
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Pin Assignments



QIP100E(14x20) "Lead-free Type"

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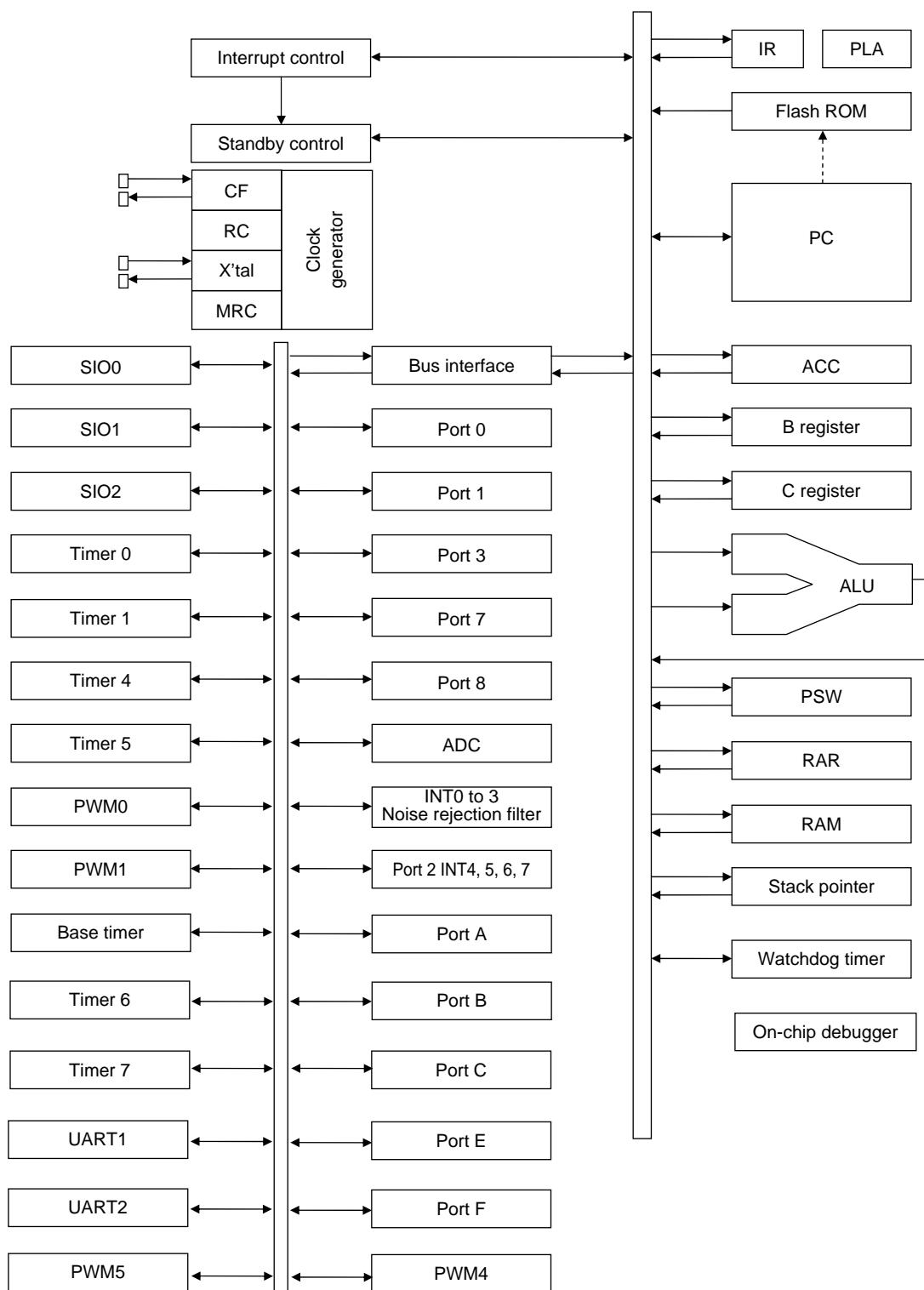
TQFP100(14×14) “Lead-free Type”

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QIP	NAME	TQFP
1	PA3/AN12	98
2	PA4/AN13	99
3	PA5/AN14	100
4	P70/INT0/T0LCP/AN8	1
5	P71/INT1/T0HCP/AN9	2
6	P72/INT2/T0IN/T0LCP	3
7	P73/INT3/T0IN/T0HCP	4
8	$\overline{\text{RES}}$	5
9	XT1/AN10	6
10	XT2/AN11	7
11	V_{SS1}	8
12	CF1	9
13	CF2	10
14	V_{DD1}	11
15	P80/AN0	12
16	P81/AN1	13
17	P82/AN2	14
18	P83/AN3	15
19	P84/AN4	16
20	P85/AN5	17
21	P86/AN6	18
22	P87/AN7	19
23	P10/SO0	20
24	P11/SI0/SB0	21
25	P12/SCK0	22
26	P13/SO1	23
27	P14/SI1/SB1	24
28	P15/SCK1	25
29	P16/T1PWM	26
30	P17/T1PWMH/BUZ	27
31	PE0	28
32	PE1	29
33	PE2	30
34	PE3	31
35	PE4	32
36	PE5	33
37	PE6	34
38	PE7	35
39	V_{SS4}	36
40	V_{DD4}	37
41	PF0	38
42	PF1	39
43	PF2	40
44	PF3	41
45	PF4	42
46	PF5	43
47	PF6	44
48	PF7	45
49	SI2P0/SO2	46
50	SI2P1/SI2/SB2	47

QIP	NAME	TQFP
51	SI2P2/SCK2	48
52	SI2P3/SCK20	49
53	PWM1	50
54	PWM0	51
55	V_{DD2}	52
56	V_{SS2}	53
57	P00	54
58	P01	55
59	P02	56
60	P03	57
61	P04	58
62	P05/CKO	59
63	P06/T6O	60
64	P07/T7O	61
65	P20/INT4/T1IN/T0LCP/T0HCP/INT6/T0LCP1	62
66	P21/INT4/T1IN/T0LCP/T0HCP	63
67	P22/INT4/T1IN/T0LCP/T0HCP	64
68	P23/INT4/T1IN/T0LCP/T0HCP	65
69	P24/INT5/T1IN/T0LCP/T0HCP/INT7/T0HCP1	66
70	P25/INT5/T1IN/T0LCP/T0HCP	67
71	P26/INT5/T1IN/T0LCP/T0HCP	68
72	P27/INT5/T1IN/T0LCP/T0HCP	69
73	P30/PWM4	70
74	P31/PWM5	71
75	P32/UTX1	72
76	P33/URX1	73
77	P34/UTX2	74
78	P35/URX2	75
79	P36	76
80	PB7	77
81	PB6	78
82	PB5	79
83	PB4	80
84	PB3	81
85	PB2	82
86	PB1	83
87	PB0	84
88	V_{SS3}	85
89	V_{DD3}	86
90	PC7/DBG2	87
91	PC6/DBG1	88
92	PC5/DBG0	89
93	PC4	90
94	PC3	91
95	PC2	92
96	PC1	93
97	PC0	94
98	PA0	95
99	PA1	96
100	PA2	97

System Block Diagram



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Pin Description

Pin Name	I/O	Description	Option																														
V _{SS1} , V _{SS2} V _{SS3} , V _{SS4}	-	- Power supply pin	No																														
V _{DD1} , V _{DD2} V _{DD3} , V _{DD4}	-	+ Power supply pin	No																														
Port 0 P00 to P07	I/O	<ul style="list-style-type: none"> • 8-bit I/O port • I/O specifiable in 4-bit units • Pull-up resistor can be turned on and off in 4-bit units • HOLD release input • Port 0 interrupt input • Pin functions <ul style="list-style-type: none"> P05: System clock output P06: Timer 6 toggle output P07: Timer 7 toggle output 	Yes																														
Port 1 P10 to P17	I/O	<ul style="list-style-type: none"> • 8-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistor can be turned on and off in 1-bit units • Pin functions <ul style="list-style-type: none"> P10: SIO0 data output P11: SIO0 data input, bus I/O P12: SIO0 clock I/O P13: SIO1 data output P14: SIO1 data input, bus I/O P15: SIO1 clock I/O P16: Timer 1 PWML output P17: Timer 1 PWMH output, Beeper output 	Yes																														
Port 2 P20 to P27	I/O	<ul style="list-style-type: none"> • 8-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistor can be turned on and off in 1-bit units • Other functions <ul style="list-style-type: none"> P20: INT4 input/HOLD reset input/timer 1 event input/timer 0L capture input/timer 0H capture input/INT6 input/timer 0L capture 1 input P21 to P23: INT4 input/HOLD reset input/timer 1 event input/timer 0L capture input/timer 0H capture input P24: INT5 input/HOLD reset input/timer 1 event input/timer 0L capture input/timer 0H capture input/INT7 input/timer 0H capture 1 input P25 to P27: INT5 input/HOLD reset input/timer 1 event input/timer 0L capture input/timer 0H capture input Interrupt acknowledge type • Interrupt acknowledge type <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th></th><th>Rising</th><th>Falling</th><th>Rising/ Falling</th><th>H level</th><th>L level</th></tr> </thead> <tbody> <tr> <td>INT4</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td></tr> <tr> <td>INT5</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td></tr> <tr> <td>INT6</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td></tr> <tr> <td>INT7</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td></tr> </tbody> </table> 		Rising	Falling	Rising/ Falling	H level	L level	INT4	enable	enable	enable	disable	disable	INT5	enable	enable	enable	disable	disable	INT6	enable	enable	enable	disable	disable	INT7	enable	enable	enable	disable	disable	Yes
	Rising	Falling	Rising/ Falling	H level	L level																												
INT4	enable	enable	enable	disable	disable																												
INT5	enable	enable	enable	disable	disable																												
INT6	enable	enable	enable	disable	disable																												
INT7	enable	enable	enable	disable	disable																												
Port 3 P30 to P36	I/O	<ul style="list-style-type: none"> • 7-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistor can be turned on and off in 1-bit units • Pin functions <ul style="list-style-type: none"> P30: PWM4 output P31: PWM5 output P32: UART1 transmit P33: UART1 receive P34: UART2 transmit P35: UART2 receive 	Yes																														

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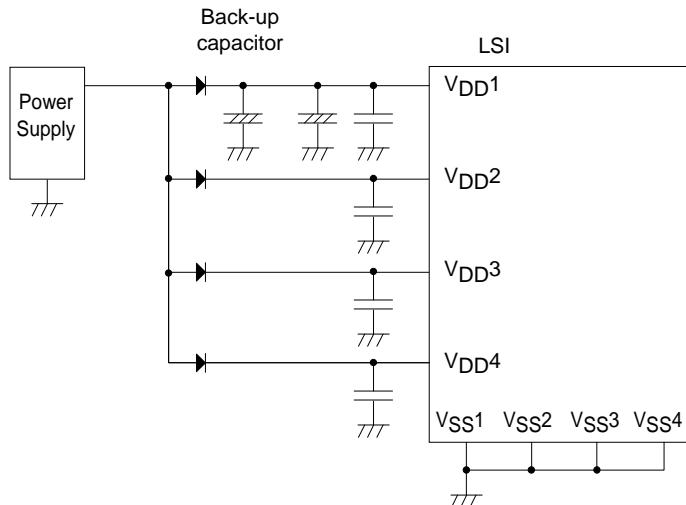
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Pin Name	I/O	Description	Option																														
Port 7	I/O	<ul style="list-style-type: none"> • 4-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistor can be turned on and off in 1-bit units • Other functions 	No																														
P70 to P73		<ul style="list-style-type: none"> P70: INT0 input/HOLD release input/Timer 0L capture input/Output for watchdog timer P71: INT1 input/HOLD release input/Timer 0H capture input P72: INT2 input/HOLD release input/Timer 0 event input/Timer 0L capture input P73: INT3 input with noise filter/Timer 0 event input/Timer 0H capture input • Interrupt acknowledge type <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th></th><th>Rising</th><th>Falling</th><th>Rising/ Falling</th><th>H level</th><th>L level</th></tr> </thead> <tbody> <tr> <td>INT0</td><td>enable</td><td>enable</td><td>disable</td><td>enable</td><td>enable</td></tr> <tr> <td>INT1</td><td>enable</td><td>enable</td><td>disable</td><td>enable</td><td>enable</td></tr> <tr> <td>INT2</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>enable</td></tr> <tr> <td>INT3</td><td>enable</td><td>enable</td><td>enable</td><td>enable</td><td>enable</td></tr> </tbody> </table> <ul style="list-style-type: none"> • AD converter input port: AN8 (P70), AN9 (P71) 		Rising	Falling	Rising/ Falling	H level	L level	INT0	enable	enable	disable	enable	enable	INT1	enable	enable	disable	enable	enable	INT2	enable	enable	enable	disable	enable	INT3	enable	enable	enable	enable	enable	
	Rising	Falling	Rising/ Falling	H level	L level																												
INT0	enable	enable	disable	enable	enable																												
INT1	enable	enable	disable	enable	enable																												
INT2	enable	enable	enable	disable	enable																												
INT3	enable	enable	enable	enable	enable																												
Port 8	I/O	<ul style="list-style-type: none"> • 8-bit I/O port • I/O specifiable in 1-bit units • Other functions 	No																														
P80 to P87		P80 to P87: AD converter input port																															
Port A	I/O	<ul style="list-style-type: none"> • 6-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistor can be turned on and off in 1-bit units 	Yes																														
PA0 to PA5																																	
Port B	I/O	<ul style="list-style-type: none"> • 8-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistor can be turned on and off in 1-bit units 	Yes																														
PB0 to PB7																																	
Port C	I/O	<ul style="list-style-type: none"> • 8-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistor can be turned on and off in 1-bit units • Pin functions 	Yes																														
PC0 to PC7		PC5 to PC7: On-chip Debugger																															
Port E	I/O	<ul style="list-style-type: none"> • 8-bit I/O port • I/O specifiable in 2-bit units • Pull-up resistor can be turned on and off in 1-bit units 	No																														
PE0 - PE7																																	
Port F	I/O	<ul style="list-style-type: none"> • 8-bit I/O port • I/O specifiable in 2-bit units • Pull-up resistor can be turned on and off in 1-bit units 	No																														
PF0 to PF7																																	
SIO2 Port	I/O	<ul style="list-style-type: none"> • 4-bit I/O port • I/O specifiable in 1-bit units • Shared functions: 	No																														
SI2P0 to SI2P3		<ul style="list-style-type: none"> SI2P0: SIO2 data output SI2P1: SIO2 data input, bus input/output SI2P2: SIO2 clock input/output SI2P3: SIO2 clock output 																															
PWM0	O	<ul style="list-style-type: none"> PWM0 output port General-purpose I/O available 	No																														
PWM1	O	<ul style="list-style-type: none"> PWM1 output port General-purpose I/O available 	No																														
RES	I	Reset pin	No																														
XT1	I	<ul style="list-style-type: none"> Input terminal for 32.768kHz X'tal oscillation Shared functions: 	No																														
		<ul style="list-style-type: none"> AN10: AD converter input port General-purpose input port 																															
		Must be connected to V _{DD1} if not to be used.																															
XT2	I/O	<ul style="list-style-type: none"> Output terminal for 32.768kHz X'tal oscillation Shared functions: 	No																														
		<ul style="list-style-type: none"> AN11: AD converter input port General-purpose I/O port 																															
		Must be set for oscillation and kept open if not to be used.																															
CF1	I	Ceramic resonator input pin	No																														
CF2	O	Ceramic resonator output pin	No																														

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(Example 2) The high-level output at the ports is unstable when the HOLD mode backup is in effect.



Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$, $V_{SS1} = V_{SS2} = V_{SS3} = V_{SS4} = 0\text{V}$

Parameter	Symbol	Pins/Remarks	Conditions	$V_{DD}[\text{V}]$	min	typ	max	unit	
Maximum supply voltage	V_{DD} max	$V_{DD1}, V_{DD2}, V_{DD3}, V_{DD4}$	$V_{DD1}=V_{DD2}=V_{DD3}=V_{DD4}$		-0.3		+6.5	V	
Input voltage	$V_I(1)$	XT1, CF1			-0.3		$V_{DD}+0.3$		
Input/Output voltage	$V_{IO}(1)$	Ports 0, 1, 2 Ports 3, 7, 8 Ports A, B, C, E, F SI2P0 to SI2P3 PWM0, PWM1, XT2			-0.3		$V_{DD}+0.3$		
High level output current	Peak output current	IOPH(1) IOPH(2) IOPH(3)	Ports 0, 1, 2, 3 Ports A, B, C, E, F SI2P0 to SI2P3 PWM0, PWM1 P71 to P73	CMOS output select per 1 application pin Per 1 application pin. Per 1 application pin.		-10 -20 -5			
	Average output current (Note1-1)	IOM(1) IOM(2) IOM(3)	Ports 0, 1, 2, 3 Ports A, B, C, E, F SI2P0 to SI2P3 PWM0, PWM1 P71 to P73	CMOS output select per 1 application pin Per 1 application pin. Per 1 application pin.		-7.5 -15 -3			
	Total output current	$\Sigma I_{OAH}(1)$ $\Sigma I_{OAH}(2)$ $\Sigma I_{OAH}(3)$ $\Sigma I_{OAH}(4)$ $\Sigma I_{OAH}(5)$ $\Sigma I_{OAH}(6)$ $\Sigma I_{OAH}(7)$ $\Sigma I_{OAH}(8)$ $\Sigma I_{OAH}(9)$ $\Sigma I_{OAH}(10)$	P71 to P73 PWM0, PWM1 SI2P0 to SI2P3 Ports 0, 2, 3 Ports 0, 2, 3 Port B Ports A, C Ports A, B, C Port F Ports 1, E Ports 1, E, F	Total of all applicable pins Total of all applicable pins		-10 -20 -30 -50 -20 -20 -40 -20 -20 -40			

Note 1-1: Average output current is average of current in 100ms interval.

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Parameter	Symbol	Pins/Remarks	Conditions	Specification			
				V _{DD} [V]	min	typ	max
Peak output current	IOPL(1)	P02 to P07 Ports 1, 2, 3 Ports A, B, C, E, F SI2P0 to SI2P3 PWM0, PWM1	Per 1 application pin.				20
	IOPL(2)	P00, P01	Per 1 application pin.				30
	IOPL(3)	Ports 7, 8, XT2	Per 1 application pin.				10
Average output current (Note1-1)	IOML(1)	P02 to P07 Ports 1, 2, 3 Ports A, B, C, E, F SI2P0 to SI2P3 PWM0, PWM1	Per 1 application pin.				15
	IOML(2)	P00, P01	Per 1 application pin.				20
	IOML(3)	Ports 7, 8, XT2	Per 1 application pin.				7.5
Low level output current	ΣIOAL(1)	Port 7, XT2	Total of all applicable pins				15
	ΣIOAL(2)	Port 8	Total of all applicable pins				15
	ΣIOAL(3)	Ports 7, 8, XT2	Total of all applicable pins				20
	ΣIOAL(4)	PWM0, PWM1 SI2P0 to SI2P3	Total of all applicable pins				40
	ΣIOAL(5)	Ports 0, 2, 3	Total of all applicable pins				80
	ΣIOAL(6)	Ports 0, 2, 3 PWM0, PWM1 SI2P0 to SI2P3	Total of all applicable pins				120
	ΣIOAL(7)	Port B	Total of all applicable pins				40
	ΣIOAL(8)	Ports A, C	Total of all applicable pins				40
	ΣIOAL(9)	Ports A, B, C	Total of all applicable pins				80
	ΣIOAL(10)	Port F	Total of all applicable pins				40
	ΣIOAL(11)	Ports 1, E	Total of all applicable pins				70
	ΣIOAL(12)	Ports 1, E, F	Total of all applicable pins				110
Maximum power dissipation	Pd max	QIP100E(14×20)					523
		TQFP100(14×14)					364
Operating ambient temperature	Topr				-20		+70
Storage ambient temperature	Tstg				-55		+125

Note 1-1: Average output current is average of current in 100ms interval.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

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Recommended Operating Range at $T_a = -20^{\circ}\text{C}$ to $+70^{\circ}\text{C}$, $V_{SS1} = V_{SS2} = V_{SS3} = V_{SS4} = 0\text{V}$

Parameter	Symbol	Pins/Remarks	Conditions	Specification				unit
				$V_{DD}[\text{V}]$	min	typ	max	
Operating supply voltage (Note2-1)	$V_{DD}(1)$	$V_{DD1}=V_{DD2}=V_{DD3}=V_{DD4}$	$0.245\mu\text{s} \leq t_{CYC} \leq 200\mu\text{s}$		4.5		5.5	V
			$0.367\mu\text{s} \leq t_{CYC} \leq 200\mu\text{s}$		3.0		5.5	
			$0.588\mu\text{s} \leq t_{CYC} \leq 200\mu\text{s}$		2.5		5.5	
Memory sustaining supply voltage	V_{HD}	$V_{DD1}=V_{DD2}=V_{DD3}=V_{DD4}$	RAM and register contents in HOLD mode.		2.0		5.5	
High level input voltage	$V_{IH}(1)$	Ports 1, 2, 3 SI2P0 to SI2P3 P71 to P73 P70 port input/interrupt side		2.5 to 5.5	$0.3V_{DD} + 0.7$		V_{DD}	V
	$V_{IH}(2)$	Ports 0, 8 Ports A, B, C, E, F PWM0, PWM1		2.5 to 5.5	$0.3V_{DD} + 0.7$		V_{DD}	
	$V_{IH}(3)$	P70 Watchdog timer side		2.5 to 5.5	$0.9V_{DD}$		V_{DD}	
	$V_{IH}(4)$	XT1, XT2, CF1, RES		2.5 to 5.5	$0.75V_{DD}$		V_{DD}	
Low level input voltage	$V_{IL}(1)$	Ports 1, 2, 3 SI2P0 to SI2P3 P71 to P73 P70 port input/interrupt		2.5 to 5.5	V_{SS}		$0.1V_{DD} + 0.4$	μs
	$V_{IL}(2)$	Ports 0, 8 Ports A, B, C, E, F PWM0, PWM1		2.5 to 5.5	V_{SS}		$0.15V_{DD} + 0.4$	
	$V_{IL}(5)$	Port 70 Watchdog timer		2.5 to 5.5	V_{SS}		$0.8V_{DD} - 1.0$	
	$V_{IL}(6)$	XT1, XT2, CF1, RES		2.5 to 5.5	V_{SS}		$0.25V_{DD}$	
Instruction cycle time	t_{CYC} (Note2-2)			4.5 to 5.5	0.245		200	μs
				3.0 to 5.5	0.367		200	
				2.5 to 5.5	0.588		200	
External system clock frequency	FEXCF(1)	CF1	<ul style="list-style-type: none"> CF2 pin open System clock frequency division rate=1/1 External system clock duty=50±5% 	4.5 to 5.5	0.1		12	MHz
				3.0 to 5.5	0.1		8	
				2.5 to 5.5	0.1		5	
			<ul style="list-style-type: none"> CF2 pin open System clock frequency division rate=1/2 	4.5 to 5.5	0.2		24.4	
				3.0 to 5.5	0.2		16	
				2.5 to 5.5	0.2		10	
Oscillation frequency range (Note2-3)	FmCF(1)	CF1, CF2	10MHz ceramic oscillation See Fig. 1.	4.5 to 5.5		10		MHz
	FmCF(2)	CF1, CF2	8MHz ceramic oscillation See Fig. 1.	3.0 to 5.5		8		
	FmCF(3)	CF1, CF2	4MHz ceramic oscillation See Fig. 1.	2.5 to 5.5		5		
	FmCF(4)	CF1, CF2	12MHz ceramic oscillation See Fig. 1.	4.5 to 5.5		12		
	FmRC		Internal RC oscillation	2.5 to 5.5	0.3	1.0	2.0	
	FmMRC		Frequency variable RC oscillation source oscillation	2.5 to 5.5		16		
	FsX'tal	XT1, XT2	32.768kHz crystal oscillation. See Fig. 2.	2.5 to 5.5		32.768		kHz

Note 2-1: V_{DD} must be held greater than or equal to 3.0V in the flash ROM onboard programming mode.

Note 2-2: Relationship between t_{CYC} and oscillation frequency is $3/F_{mCF}$ at a division ratio of 1/1 and $6/F_{mCF}$ at a division ratio of 1/2.

Note 2-3: See Tables 1 and 2 for the oscillation constants.

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2. SIO1 Serial I/O Characteristics (Note 4-2-1)

Parameter		Symbol	Pins/ Remarks	Conditions	V_{DD} [V]	Specification					
						min	typ	max	unit		
Serial clock	Input clock	Frequency	Tsck(3)	SCK1(P15)	• See Fig. 6.	2.5 to 5.5	2			tCYC	
		Low level pulse width	tSCKL(3)				1				
		High level pulse width	tSCKH(3)				1				
	Output clock	Frequency	tSCK(4)	SCK1(P15)	• CMOS output selected. • See Fig. 6.	2.5 to 5.5	2			tSCK	
		Low level pulse width	tSCKL(4)				1/2				
		High level pulse width	tSCKH(4)				1/2				
Serial input	Data setup time	tsDI(2)	SI1(P14), SB1(P14)	• Must be specified with respect to rising edge of SIOCLK • See fig. 6.	2.5 to 5.5	0.03				μs	
	Data hold time	thDI(2)				0.03					
Serial output	Output delay time	tdD0(4)	SO1(P13), SB1(P14)	• Must be specified with respect to falling edge of SIOCLK • Must be specified as the time to the beginning of output state change in open drain output mode. • See Fig. 6.	2.5 to 5.5			(1/3)tCYC +0.05			

Note 4-2-1: These specifications are theoretical values. Add margin depending on its use.

3. SIO2 Serial I/O Characteristics (Note 4-3-1)

Parameter		Symbol	Pins/ Remarks	Conditions	V _{DD} [V]	Specification					
						min.	typ	max.	unit		
Serial clock	Input clock	Frequency	tSCK(5)	SCK2 (SI2P2)	<ul style="list-style-type: none"> • See Fig. 6. 	2.5 to 5.5	2			tCYC	
		Low level pulse width	tSCKL(5)				1				
		High level pulse width	tSCKH(5)				1				
			tSCKHA(5a)		<ul style="list-style-type: none"> • Continuous data transmission/reception mode of SIO0 is not in use simultaneous. • See Fig. 6. • (Note 4-3-2) 		4				
			tSCKHA(5b)				7				
	Output clock O	Frequency	tSCK(6)	SCK2 (SI2P2), SCK2O (SI2P3)	<ul style="list-style-type: none"> • CMOS output selected. • See Fig. 6. 	2.5 to 5.5	4/3			tSCK	
		Low level pulse width	tSCKL(6)				1/2				
		High level pulse width	tSCKH(6)				1/2				
			tSCKHA(6a)		<ul style="list-style-type: none"> • Continuous data transmission/reception mode of SIO0 is not in use simultaneous. • CMOS output selected. • See Fig. 6. 		tSCKH(6) +(5/3)tCYC		tSCKH(6) +(10/3)tCYC		
			tSCKHA(6b)				tSCKH(6) +(5/3)tCYC		tSCKH(6) +(19/3)tCYC		
Serial input	Data setup time	tsDI(3)	SI2(SI2P1), SB2(SI2P1)		<ul style="list-style-type: none"> • Must be specified with respect to rising edge of SIOCLK • See fig. 6. 	2.5 to 5.5	0.03			μs	
	Data hold time	thDI(3)					0.03				
Serial output	Output delay time	tdD0(5)	SO2 (SI2P0), SB2(SI2P1)		<ul style="list-style-type: none"> • Must be specified with respect to falling edge of SIOCLK • Must be specified as the time to the beginning of output state change in open drain output mode. • See Fig. 6. 	2.5 to 5.5			(1/3)tCYC +0.05		

Note 4-3-1: These specifications are theoretical values. Add margin depending on its use.

Note 4-3-2: To use serial-clock-input , a time from SI2RUN being set when serial clock is "H" to the first negative edge of the serial clock must be longer than tSCKHA.

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Consumption Current Characteristics at $T_a = -20^{\circ}\text{C}$ to $+70^{\circ}\text{C}$, $V_{SS1} = V_{SS2} = V_{SS3} = V_{SS4} = 0\text{V}$

Parameter	Symbol	Pins/Remarks	Conditions	Specification				
				$V_{DD}[\text{V}]$	min	typ	max	
Normal mode consumption current (Note 7-1)	IDDOP(1)	$V_{DD1} = V_{DD2} = V_{DD3} = V_{DD4}$	<ul style="list-style-type: none"> • FmCF=10MHz ceramic oscillation mode • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to 10MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	4.5 to 5.5		9	22	mA
	IDDOP(2)		<ul style="list-style-type: none"> • FmCF=8MHz ceramic oscillation mode • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to 8MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	4.5 to 5.5		8	17	
	IDDOP(3)		<ul style="list-style-type: none"> • FmCF=5MHz ceramic oscillation mode • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to 5MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	3.0 to 4.5		4.2	12.5	
	IDDOP(4)		<ul style="list-style-type: none"> • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to internal RC oscillation • frequency variable RC oscillation stopped • 1/2 frequency division ratio. 	4.5 to 5.5		5.5	12	
	IDDOP(5)		<ul style="list-style-type: none"> • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to 1MHz with frequency variable RC oscillation • Internal RC oscillation stopped • 1/2 frequency division ratio. 	2.5 to 4.5		3	8.5	
	IDDOP(6)		<ul style="list-style-type: none"> • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode. • System clock set to 32.768kHz side. • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/2 frequency division ratio. 	4.5 to 5.5		1.2	6	
	IDDOP(7)		<ul style="list-style-type: none"> • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode. • System clock set to 1MHz with frequency variable RC oscillation • Internal RC oscillation stopped • 1/2 frequency division ratio. 	2.5 to 4.5		0.7	4	
	IDDOP(8)		<ul style="list-style-type: none"> • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode. • System clock set to 12MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	4.5 to 5.5		1.5	10	
	IDDOP(9)		<ul style="list-style-type: none"> • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode. • System clock set to 12MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/2 frequency division ratio. 	2.5 to 4.5		1	6	
	IDDOP(10)		<ul style="list-style-type: none"> • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode. • System clock set to 32.768kHz side. • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/2 frequency division ratio. 	4.5 to 5.5		45	130	μA
	IDDOP(11)		<ul style="list-style-type: none"> • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode. • System clock set to 12MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	2.5 to 4.5		22	85	
	IDDOP(12)		<ul style="list-style-type: none"> • FmCF=12MHz ceramic oscillation mode • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to 10MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	4.5 to 5.5		10.2	25	mA
HALT mode consumption current (Note 7-1)	IDDHALT(1)	$V_{DD1} = V_{DD2} = V_{DD3} = V_{DD4}$	<ul style="list-style-type: none"> • HALT mode • FmCF=10MHz ceramic oscillation mode • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to 10MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	4.5 to 5.5		4	8.5	

Note 7-1: The consumption current value includes none of the currents that flow into the output Tr and internal pull-up resistors

Continued on next page.

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Continued from preceding page.

Parameter	Symbol	Pins/Remarks	Conditions	Specification				
				V _{DD} [V]	min	typ	max	
HALT mode consumption current (Note 7-1)	IDDHALT(2)	V _{DD1} =V _{DD2} =V _{DD3} =V _{DD4}	<ul style="list-style-type: none"> • HALT mode • FmCF=8MHz ceramic oscillation mode • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to 8MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	4.5 to 5.5		3	6	mA
	IDDHALT(3)			3.0 to 4.5		1.8	3.2	
	IDDHALT(4)		<ul style="list-style-type: none"> • HALT mode • FmCF=5MHz ceramic oscillation mode • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to 5MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	4.5 to 5.5		2.2	4.5	
	IDDHALT(5)			2.5 to 4.5		1	2.8	
	IDDHALT(6)		<ul style="list-style-type: none"> • HALT mode • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to internal RC oscillation • frequency variable RC oscillation stopped • 1/2 frequency division ratio. 	4.5 to 5.5		0.45	1.5	
	IDDHALT(7)			2.5 to 4.5		0.25	1	
	IDDHALT(8)		<ul style="list-style-type: none"> • HALT mode • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode. • System clock set to 1MHz with frequency variable RC oscillation • Internal RC oscillation stopped • 1/2 frequency division ratio. 	4.5 to 5.5		1.5	4	
	IDDHALT(9)			2.5 to 4.5		0.8	3	
	IDDHALT(10)		<ul style="list-style-type: none"> • HALT mode • FmCF=0Hz (oscillation stopped) • FmX'tal=32.768kHz by crystal oscillation mode. • System clock set to 32.768kHz side. • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/2 frequency division ratio. 	4.5 to 5.5		22	75	μ A
	IDDHALT(11)			2.5 to 4.5		10	65	
	IDDHALT(12)		<ul style="list-style-type: none"> • HALT mode • FmCF=12MHz ceramic oscillation mode • FmX'tal=32.768kHz by crystal oscillation mode • System clock set to 12MHz side • Internal RC oscillation stopped • frequency variable RC oscillation stopped • 1/1 frequency division ratio. 	4.5 to 5.5		4.7	10	mA
HOLD mode consumption current	IDDHOLD(1)	V _{DD1}	<ul style="list-style-type: none"> • HOLD mode • CF1=V_{DD} or open (External clock mode) 	4.5 to 5.5		0.07	20	μ A
	IDDHOLD(2)			2.5 to 4.5		0.03	17	
Timer HOLD mode consumption current	IDDHOLD(3)		<ul style="list-style-type: none"> • Timer HOLD mode • CF1=V_{DD} or open (External clock mode) • FmX'tal=32.768kHz by crystal oscillation mode 	4.5 to 5.5		19	65	
	IDDHOLD(4)			2.5 to 4.5		6.5	55	

Note 7-1: The consumption current value includes none of the currents that flow into the output Tr and internal pull-up resistors

F-ROM Programming Characteristics at $T_a = +10^{\circ}\text{C}$ to $+55^{\circ}\text{C}$, $V_{SS1} = V_{SS2} = V_{SS3} = V_{SS4} = 0\text{V}$

Parameter	Symbol	Pins/Remarks	Conditions	Specification				
				$V_{DD}[\text{V}]$	min	typ	max	
Onboard programming current	IDDFW(1)	V_{DD1}	<ul style="list-style-type: none"> • 128-byte programming • Erasing current including 	3.0 to 5.5		30	50	mA
Programming time	tFW(1)		<ul style="list-style-type: none"> • 128-byte programming • Erasing current including • Time for setting up 128 byte data is excluded. 	3.0 to 5.5		22.5	35	ms

UART (Full Duplex) Operating Conditions at $T_a = -20^{\circ}\text{C}$ to $+70^{\circ}\text{C}$, $V_{SS1} = V_{SS2} = V_{SS3} = V_{SS4} = 0\text{V}$

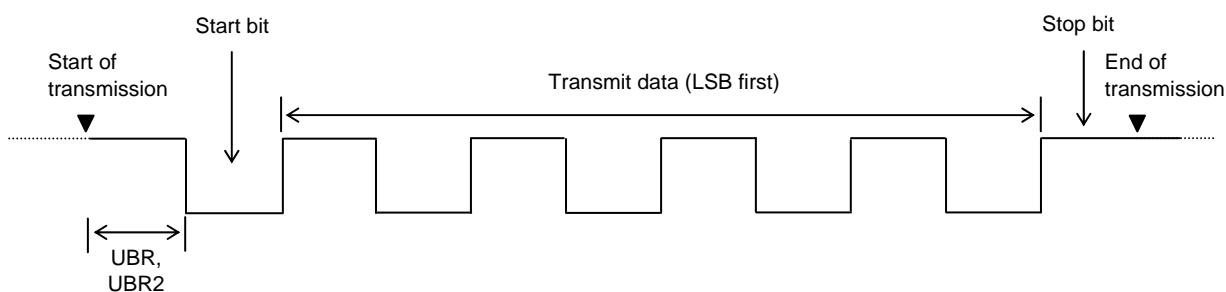
Parameter	Symbol	Pins/Remarks	Conditions	Specification				
				$V_{DD}[\text{V}]$	min	typ	max	
Transfer rate	UBR, UBR2	UTX1(P32), RTX1(P33), UTX2(P33), RTX2(P34)		2.5 to 5.5	16/3		8192/3	tCYC

Data length : 7/8/9 bits (LSB first)

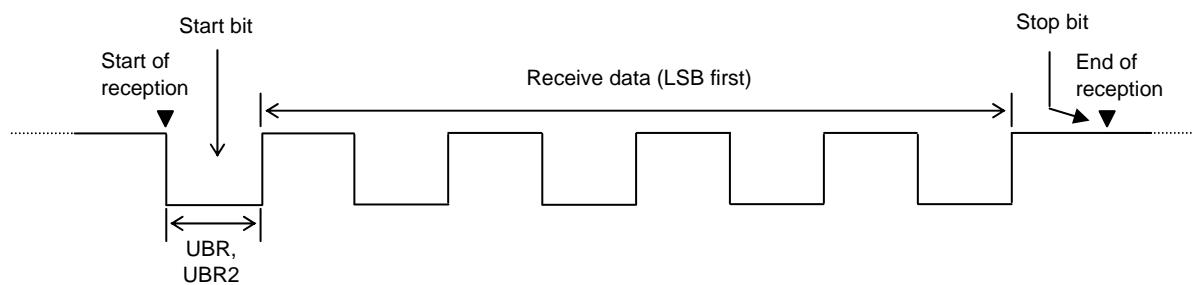
Stop bits : 1-bit (2-bit in continuous data transmission)

Parity bits : None

Example of Continuous 8-bit Data Transmission Mode Processing (First Transmit Data = 55H)



Example of Continuous 8-bit Data Reception Mode Processing (First Receive Data = 55H)



Characteristics of a Sample Main System Clock Oscillation Circuit

Given below are the characteristics of a sample main system clock oscillation circuit that are measured using a Our designated oscillation characteristics evaluation board and external components with circuit constant values with which the oscillator vendor confirmed normal and stable oscillation.

Table 1 Characteristics of a Sample Main System Clock Oscillator Circuit with a Ceramic Oscillator

Nominal Frequency	Vendor Name	Oscillator Name	Circuit Constant				Operating Voltage Range [V]	Oscillation Stabilization Time		Remarks
			C1 [pF]	C2 [pF]	Rf1 [Ω]	Rd1 [Ω]		typ [ms]	max [ms]	
12MHz	MURATA	CSTCE12M0G52-R0	(10)	(10)	Open	470	4.5 to 5.5	0.05	0.15	Internal C1,C2
10MHz		CSTCE10M0G52-R0	(10)	(10)	Open	1.0k	4.5 to 5.5	0.05	0.15	Internal C1,C2
8MHz		CSTLS10M0G53-B0	(15)	(15)	Open	680	4.5 to 5.5	0.05	0.15	Internal C1,C2
		CSTCE8M00G52-R0	(10)	(10)	Open	2.2k	3.0 to 5.5	0.05	0.15	Internal C1,C2
		CSTLS8M00G53-B0	(15)	(15)	Open	680	3.0 to 5.5	0.05	0.15	Internal C1,C2
5MHz		CSTCR5M00G53-R0	(15)	(15)	Open	3.3k	2.5 to 5.5	0.05	0.15	Internal C1,C2
		CSTLS5M00G53-B0	(15)	(15)	Open	1.5k	2.5 to 5.5	0.05	0.15	Internal C1,C2

The oscillation stabilization time refers to the time interval that is required for the oscillation to get stabilized after VDD goes above the operating voltage lower limit (see Fig. 4).

Characteristics of a Sample Subsystem Clock Oscillator Circuit

Given below are the characteristics of a sample subsystem clock oscillation circuit that are measured using a Our designated oscillation characteristics evaluation board and external components with circuit constant values with which the oscillator vendor confirmed normal and stable oscillation.

Table 2 Characteristics of a Sample Subsystem Clock Oscillator Circuit with a Crystal Oscillator

Nominal Frequency	Vendor Name	Oscillator Name	Circuit Constant				Operating Voltage Range [V]	Oscillation Stabilization Time		Remarks
			C3 [pF]	C4 [pF]	Rf2 [Ω]	Rd2 [Ω]		typ [s]	max [s]	
32.768kHz	SEIKO EPSON	MC-306	18	18	Open	560k	2.5 to 5.5	1.3	3.0	Applicable CL value=12.5pF

The oscillation stabilization time refers to the time interval that is required for the oscillation to get stabilized after the instruction for starting the subclock oscillation circuit is executed and to the time interval that is required for the oscillation to get stabilized after the HOLD mode is reset (see Fig. 4).

Note: The components that are involved in oscillation should be placed as close to the IC and to one another as possible because they are vulnerable to the influences of the circuit pattern.

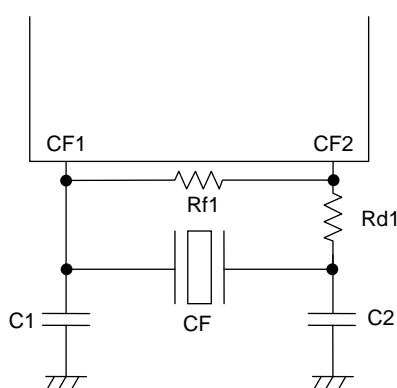


Figure 1 Ceramic Oscillator Circuit

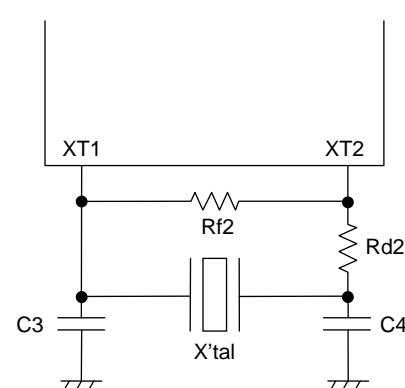


Figure 2 Crystal Oscillator Circuit

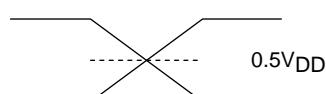
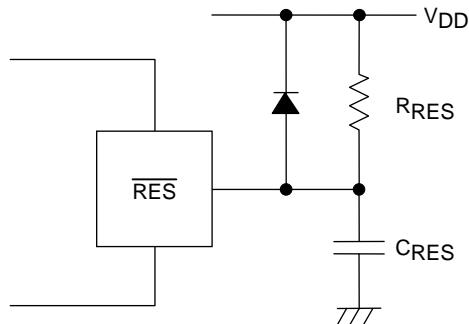


Figure 3 AC Timing Measurement Point



Note:

Select C_{RES} and R_{RES} value to assure that at least 200μs reset time is generated after the V_{DD} becomes higher than the minimum operating voltage.

Figure 5 Reset Circuit

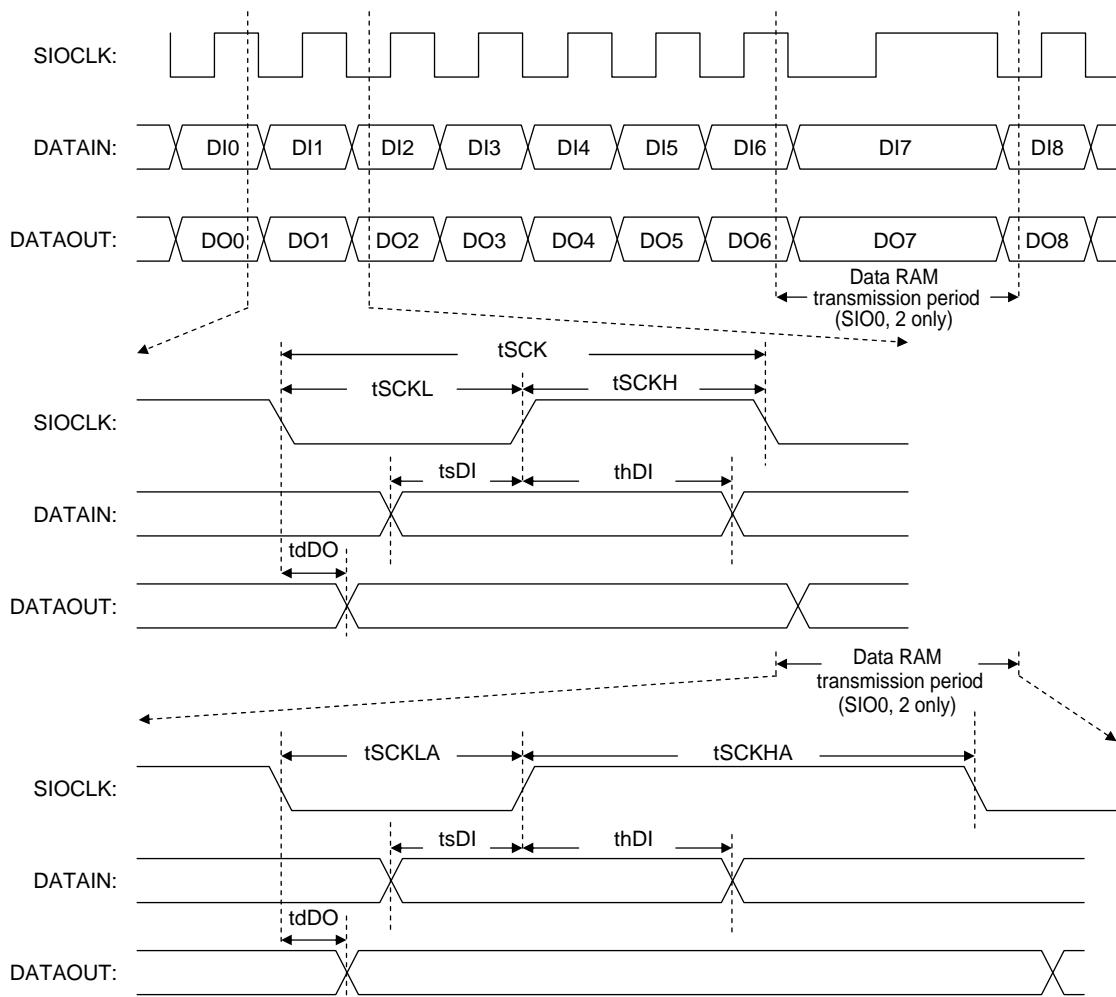


Figure 6 Serial I/O Test Condition

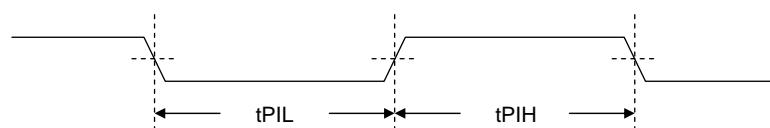


Figure 7 Pulse Input Timing Signal Waveform

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